

/ Descriptions

Silicon NPN transistor in a TO-220F Plastic Package.

/ Features

Low $V_{CE(sat)}$, High total power dissipation, complementary pair with 2SB1375.

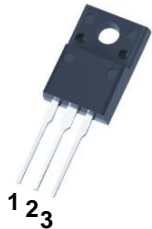
/ Applications

Audio frequency power amplifier applications.

/ Equivalent Circuit



/ Pinning



PIN1 Base PIN 2 Collector PIN 3 Emitter

/ h_{FE} Classifications & Marking

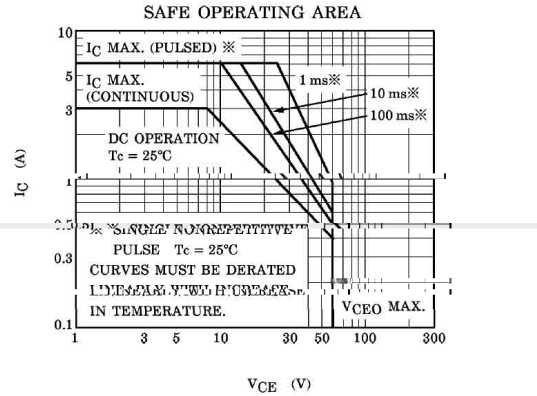
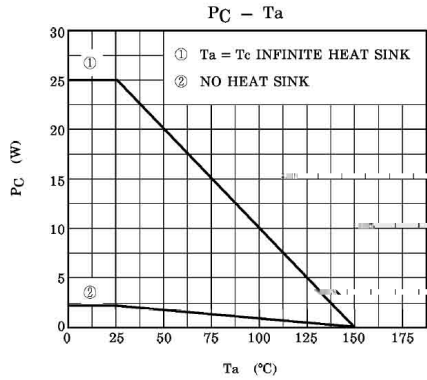
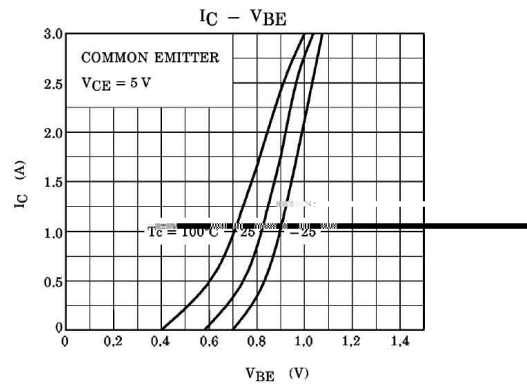
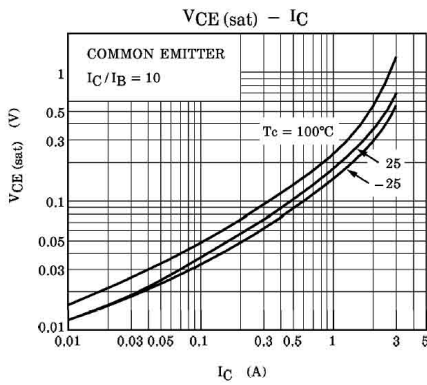
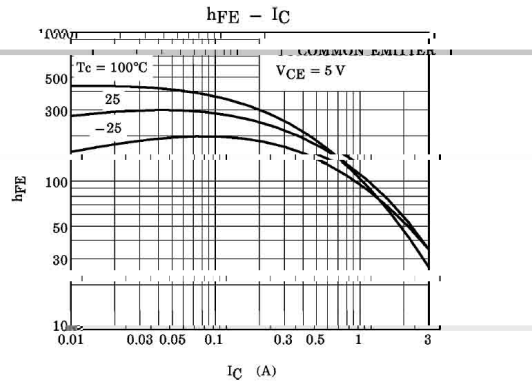
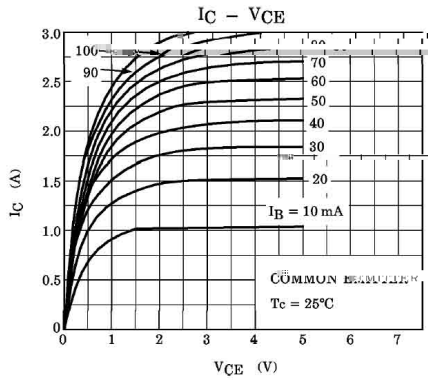
See Marking Instructions.

/ Absolute Maximum Ratings(Ta=25

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	60	V
Collector to Emitter Voltage	V_{CEO}	60	V
Emitter to Base Voltage	V_{EBO}	7.0	V
Collector Current - Continuous	I_C	3	A
Base Current	I_B	0.5	A
Collector Power Dissipation	P_C	2	W
Collector Power Dissipation	$P_C (T_c=25 \text{ })$	25	W
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector to Emitter Breakdown Voltage	V_{CEO}	$I_C=50mA \quad I_B=0$	60			V
Collector Cut-Off Current	I_{CBO}	$V_{CB}=60V \quad I_E=0$			100	μA
Emitter Cut-Off Current	I_{EBO}	$V_{EB}=7.0V \quad I_C=0$			100	μA
DC Current Gain	$h_{FE(1)}$	$V_{CE}=5V \quad I_C=0.5A$	100		320	
	$h_{FE(2)}$	$V_{CE}=5V \quad I_C=2A$	20			
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=2A \quad I_B=0.2A$		0.4	1.0	V
Base to Emitter Voltage	V_{BE}	$V_{CE}=5V \quad I_C=0.5A$		0.75	1.0	V
Transition Frequency	f_T	$V_{CE}=5V \quad I_C=0.5A$		3.0		MHz
Collector output capacitance	C_{ob}	$V_{CB}=10V \quad I_E=0$ $f=1MHz$		35		pF

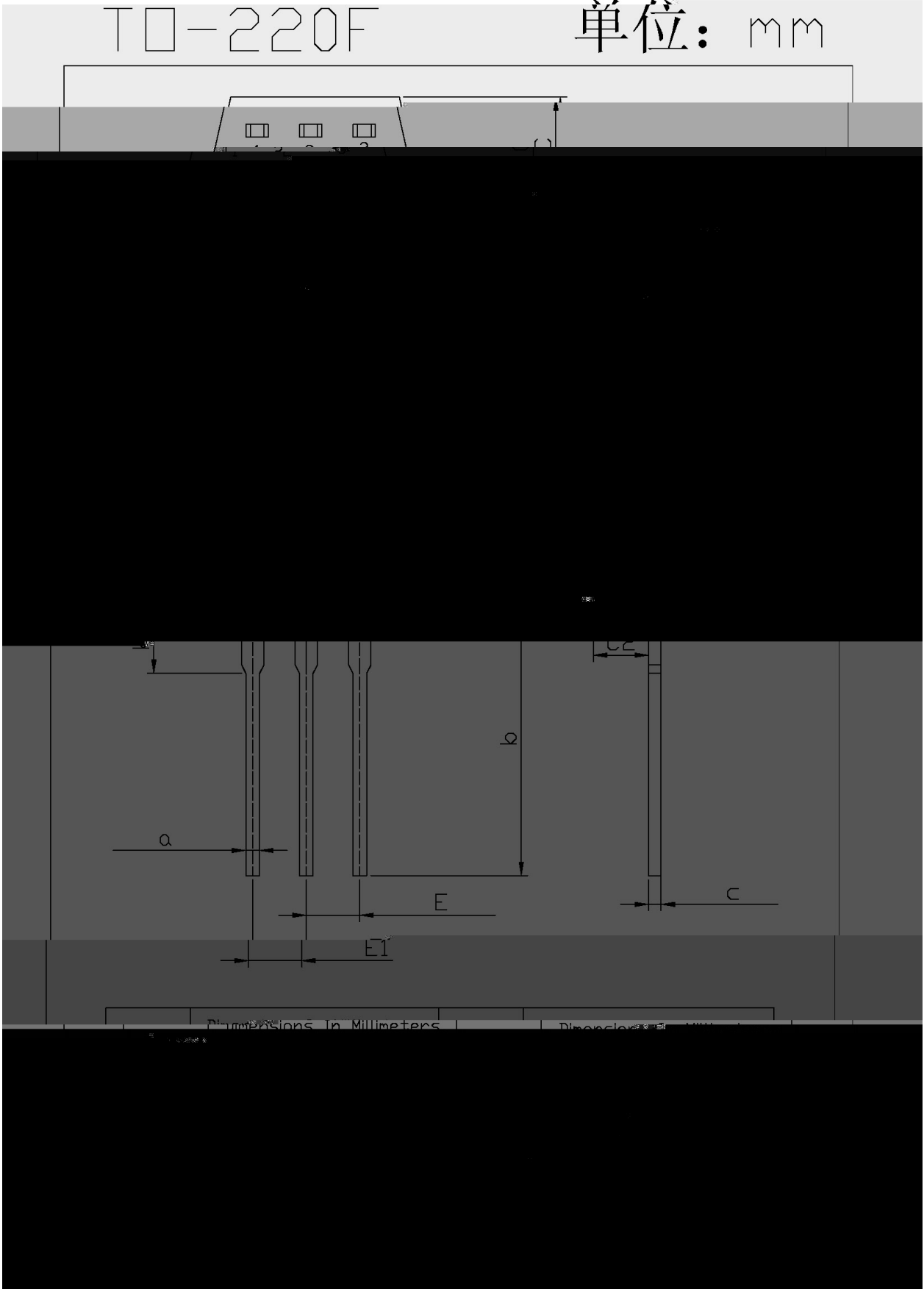
/ Electrical Characteristic Curve



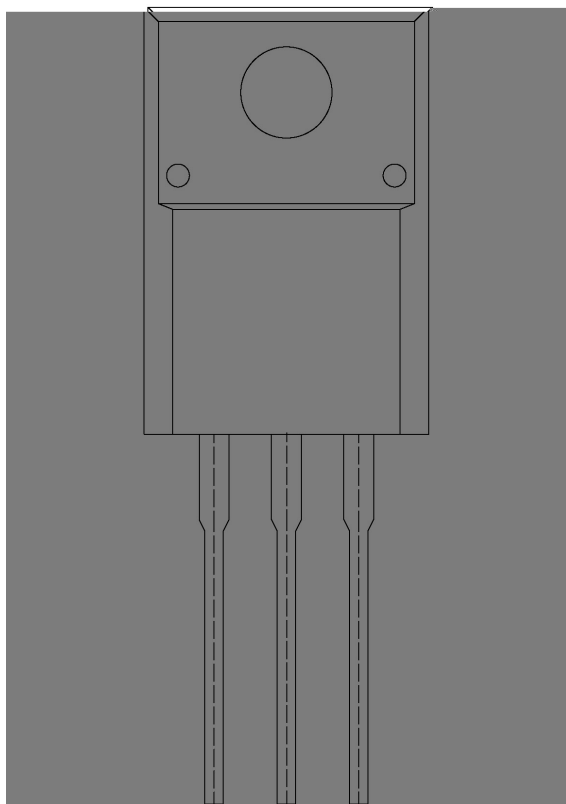
/ Package Dimensions

TO-220F

单位: mm



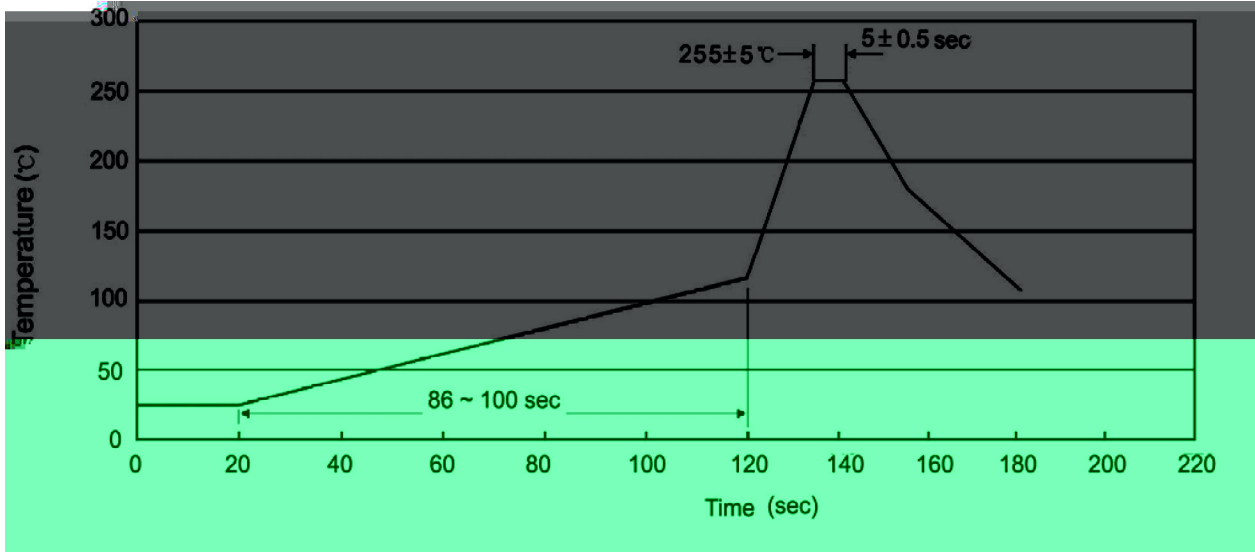
/ Marking Instructions



Note:

BR: Company Code.

() / Temperature Profile for Dip Soldering(Pb-Free)



Note:

- | | | | | | |
|---|-----|-----|----|----------|---|
| 1 | 25 | 150 | 60 | 90sec; | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 255 | 5 | 5 | 0.5sec; | 2.Peak Temp.:255 5 , Duration:5 0.5sec. |
| 3 | | | 2 | 10 /sec. | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

270 5 10 1 sec. Temp.:270±5 Time:10±1 sec

/ Packaging SPEC.

/ BULK

Package Type	Units		Dimension	(unit mm ³)
	Units/Bag	Bags/Inner Box	Units/Inner Box	Inno7x06e7FsOu6e7Ftep8308